

长沙三必得超硬材料有限公司

CHANGSHA 3 BETTER ULTRA-HARD MATERIALS CO.LTD

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Product introduction:

PCD dies- Co base have two different die blank: Self-Supported Die Blanks & Tungsten Carbide Supported Die Blanks.

Dies with tungsten carbide supported eie blanks can withstand greater pull, more used in the manufacture of large aperture mold embryo, pulling a thicker diameter of wire - 3mm or more wire is recommended with carbide ring.

Self-Supported Die Blanks:

ADDMA ⁽¹⁾ Designation	Nominal Diamond Diameter x Thickness [mm x mm]	Product	Designat	ion / Average	Grain Size Diamond Diamond Diamond Diamond Diamond Thickness	Total Blank Diameter	
D-6	3.1 x 1.0	5010-TS	5010-MF	5010-TSC			
D-12	3.1 x 1.5	5015-TS	5015-MF	5015-TSC		(Not	
D-15	5.2 x 2.5	5025-TS	5025-MF	5025-TSC		Applicable)	
D-18	5.2 x 3.5	5035-TS	5035-MF	5035-TSC			



Tungsten Carbide Supported Die Blank

ADDMA ^{rt} Designation	Nominal Diamond Diameter x Thickness [mm x mm]	Product Designation / Average Grain Size						
		3 µm	5 µm	25 µm	Diamond Diameter Diamond Thickness Tod Blank Diameter	Total Blank Diameter		
					50 µm			
D-12	1.5 x 1.5			5235		3.99 ± 0.013		
D-15	4.0 x 2.3	5823		5223	5430	8.12 ± 0.013		
D-18	4.0 x 2.9	5829		5229	5435	8.12 ± 0.013		
D-21	7.0 x 4.0		5840	5240	5530	13.65 ± 0.013		
D-24	7.0 x 5.3		5853	5253	5535	13.65 ± 0.013		
	13.0 x 7.0			5225	5725	24.13 ± 0.025		
D-27	13.0 x 8.7			5208	5730	24.13 ± 0.025		
D-30	13.0 x 11.6			5211	5735	24.13 ± 0.025		
	18.6 x 13.5			5913		34.00 ± 0.025		
D-33	18.6 x 15.5			5915		34.00 ± 0.025		
	18.6 x 17.5			5917		34.00 ± 0.025		
D-36	18.6 x 18.5			5918		34.00 ± 0.025		



Production Process

